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1. Company Summary

EMNEX is specializing in the manufacture of electronic products that supply customers with best quality and service in the best condition with pleasant production environment.

 First basement level up to 4th aboveground Floors (Total floor space is 4,900m²)

Customer-specific Line6 Room

Clean for manufacturing environment

Supported ONE-STOP Service

- Best quality
- Desired delivery
- Reasonable price

Increase customer value

ner EMnex

• SMT: 4 LINE

IMT (DIP) : 4 LINE

- Small Size Clean Room
- Robot solder Line
- (Selective & Pointer Solder)
- Function & Test

Assembly: 10 Cell Line

Best manufacturing infrastructure

Best quality customer impressions

- Create a specification approved every product
- Stabilization of manufacturing to initial products
- ERP System
- Report process flow sheet every lot

- From Development
 Circuit and PCB artwork,
 Technical review, Engineering
 sample, Customer spec review,
 Inspector and Jlg design
- To product shipment
 Component purchase, SMT,
 IMT, Function, Testing, Repair,
 Assembly, Packaging,
 QC inspection, Shipment

Company Contents



Address : Samsung 1-ro 3-gil, Hwaseong-si, Gyeonggi-do, Korea, 18448

• Number of employees : 87 people (Now a days)

Representative : Young Wook Choi

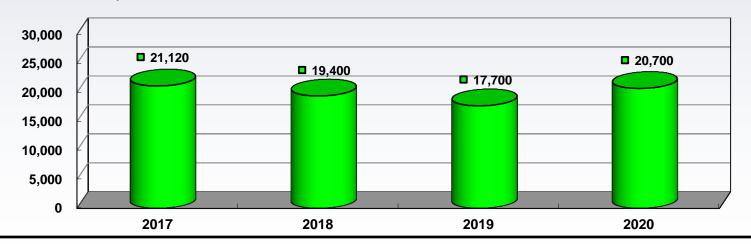
Business Status : Place_2,600m², Total floor space is 4,900m²
 New build start First basement level up to 4th aboveground Floors

Turnover: '17yr: \$21.120,000, '18yr: \$19,400,000 '19yr: \$17,700,000 '20yr: \$20,700,000 (expected).

Main Products: Controller (robot & elevator & railway vehicle), Driver (Servo, Stepping, inverter), X-RAY generator, sensor, Power electronics, Communication, Industrial Camera module.etc

Home Page : www. emnex.co.kr

(Unit: thousand, \$)





EMNEX Partnership

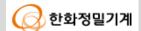
Industrial equipment





















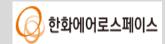




Power Electronics & Defense



ASPO









Medical













Others





























2. Company History

- 1999 yr. Incorporation, Designated as a partner company of Samsung Electronics Co., Ltd. (Manufacturing and PCB Artwork)
- 2008 vr. Establishment of Research Institute (Attached)
- 2009 yr. Selected as a promising medium Company by Gyeonggi-do Governor
 Selected as an INNOBIZ Company _ Small and Medium Business Administration a director
- 2011yr. Enternce New building (2011, 10) basement 1st, aboveground floor 4th (Total floor space is 4,900m²)
- 2012 yr. EMNEX ··· Change company name (2012, 10. 26)
- 2013 yr. Parts and material specializing company _ Ministry of Commerce, Industry and Energy
 Hyundai Rotem, PBA "A grade" Registered as a certified company (GQR-2015)
- 2014 yr. ERP SYSTEM operation.
- 2015 yr. Hanwha System (before, Samsung Thales), Registered as a defense industry company
- 2016 yr. Hanwha Techwin, QSA/ QPA Pass (quality)
 Factory registration; PSE (Japan), CCC (China), UL (U.S.A), CSA (Canada)
- 2018 yr, ISO 9001 Certification (2018 yr, SAI GLOBAL), KSO ISO9001
- 2019 yr, KSQ 9100 (AS 9100) Certification (2018 yr, KIWA KOREA),
- 2020 yr, SEMES SSQ Certification, LG Electronics, ROBOT businees, Registered as a certified company

3. Main Certification Status



(Research & Development Center)



(Promising Small and Medium Business) GyeonGi-Do Korea)



(ISO9001 certification)



(INNOBIZ COMPANY)

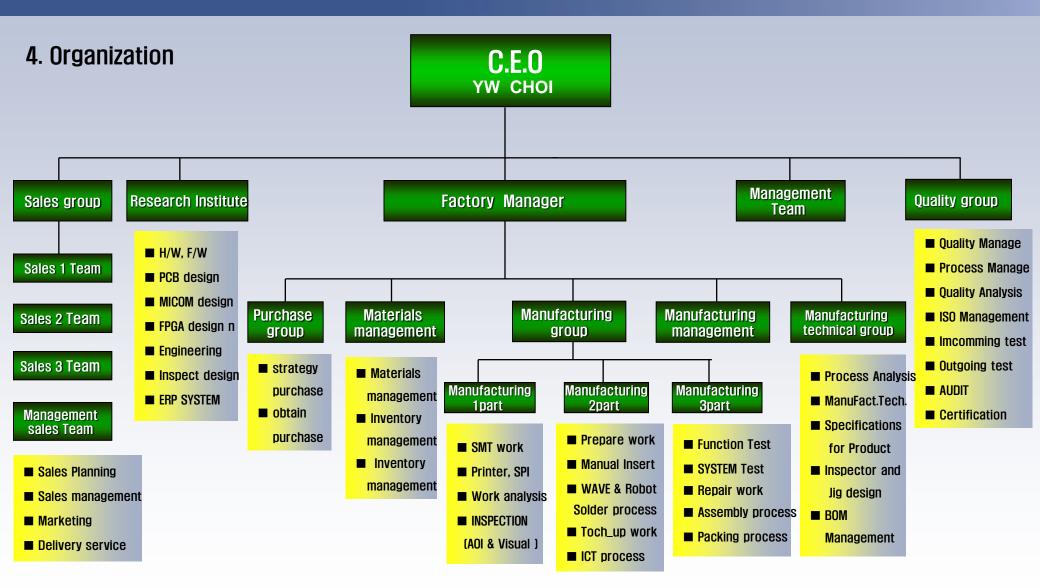


(AS 9100 certification)



(Parts and material specializing company)





5. Main manufacturing items

Controller & Driver for Industry

Robot controller series for Industrial (30 items)



EMNEX is equipped from Samsung Electronics Co., Ltd (SEC), Samsung Display Co., Ltd. (SDC) with controller and 4 axis servo pack, 6-axis controller, AGV controller, Jetting Driver, etc... (PBA and SET products)

Application



■ Motor driver and AGV controller etc..













■ InkJet system & for display and Test B'D etc for Semiconductor













■ Elevator controller and Railway vehicle control B'D













Communication

■ Optical transmission switching B'D for LTE













Medical

■ X-RAY generator and Sensor B'D











■ Battery Management System (BMS) and Medical Measure B'D

















Other

■ Power control System and Laser detector













■ Industrial camera modules, SMT, AOI, SPI controller, etc…















6. Manufacturing place

Material warehouse











SMT Line (4 Line)

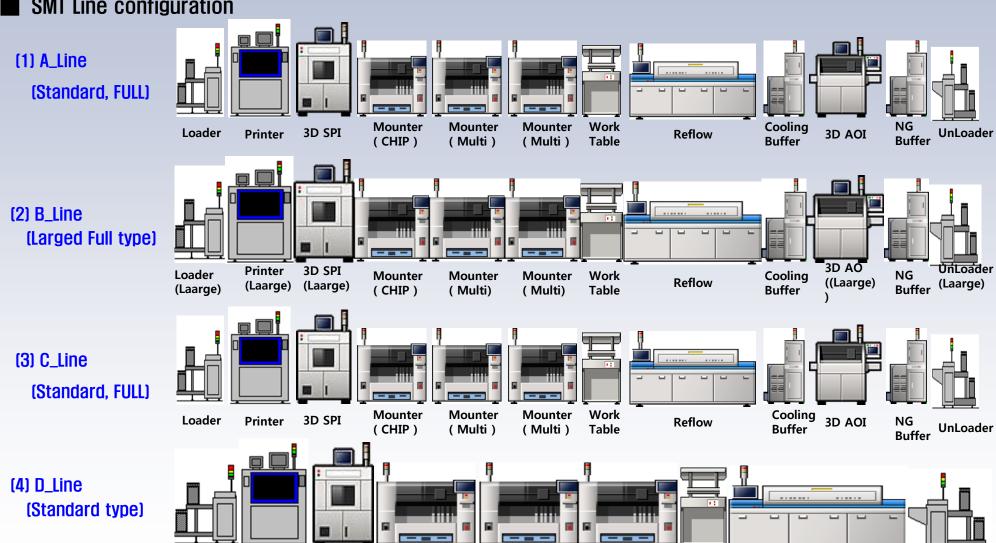
For PB_Free (ROHS)







SMT Line configuration



Manual Insert Line (DIP 4 Line)



For Lead_Free



TEST Line



TEST Line



Quality Management



< Micro Inspection >

Selective Robot Soldering Line



Pointer Robot soldering



Ceiling type humidifying system



Squeegee blade washer and inspector



X-RAY inspection M/C



PBA water washing M/C and Deionized(D/I) water maker



Coating system Line



Customer Line



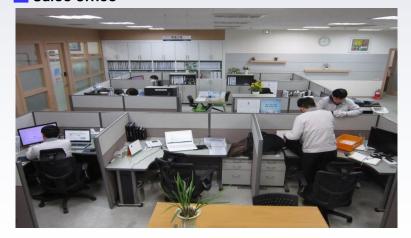
Small Clean Room



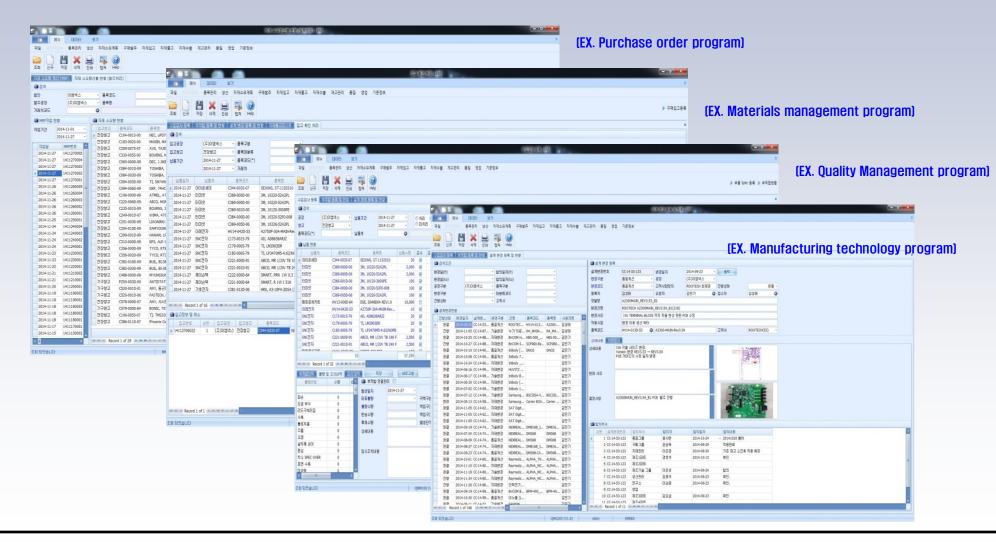
Flying Probe ICT Tester



Sales Office



EMNEX ERP SYSTEM construct and Usage (example) _ EMNEX own code system of establishing.



7. Major Manufacturing Facilities

[1/2]

| | | | | (1/2) | | |
|----------------------|--|--------|---------------------------------------|---|--|--|
| Division | Equipment name | Number | Equipment Maker | Etc (SPEC) | | |
| | Standard type mounter (SMT) | 4 | Hanwha Techwin | SM471 (2 units), SM411 (2 units) | | |
| | Multi type mounter (SMT) | 8 | Hanwha Techwin | SM482 (7 units), SM421 (1 units) | | |
| | SCREEN Printer | 4 | Tenryu Seiki (Japan), Sj Tech | TSP-1200, TSP-600, TSP-550, HP-850S | | |
| | Reflow M/C | 4 | Heller Korea | Heller MK1810 III (4 units), RoHS | | |
| OMET Allera | Solder cream checker (3D SPI) | 4 | Ko Young Technology | Aspire-3 (3D SPI) 1 unit, KY8020-2L [3 units], | | |
| SMT Line
(4 Line) | Vision inspector (Included 3D AOI) | 5 | Ko Young Technology, MASS (Japan) | Zenith (3D AOI _In-Line) (3 Units), HDL_650 [2 units] | | |
| (4 Lillo) | Router | 1 | MS Tech | DPL-T (PCB cutting) | | |
| | Nitrogen generator (N2) | 2 | Kyultron | N2 GENERATOR (2 Set) | | |
| | Ceiling injection
Humidification system | 25 | Seil Ricoh | HU-CONSTM System, Humidity maintenance,
Installation all the field | | |
| | Etc., equipment | 24 | | ade washer, squeegee blade tester, Mask washer,
Meter system, etc | | |
| IMT (Dip) Line | Auto Soldering Machine | 4 | Shin Myung | SAS-620 (2units), SAS600 (2 units) | | |
| (Auto Soldering) | PCB washer | 1 | Aqueous (USA) | Pure water maker (DI WATER) and PCB washer | | |
| (4 Line) | ICT M/C | 2 | OKANO(Japan), Samsung Electronics Co. | AT-01 (2 units) | | |
| Robot Soldering Line | Selective Robot Soldering | 2 | InterSelect (Germany) | 2 port (Used fuel, Non fuel possible) | | |
| (1 Line) | Pointer Robot soldering | 1 | MEIKO TECH (Japan) | 1 point Robot soldering machine | | |
| Test / Assembly / | Function Cell Line | 10 | self-production | Inspection / Simple assembly process | | |
| Packaging Line | ROOM for set assembly and Inspection. | 6 | Customer room | Specified customers room | | |
| Automatic coating | 3 Conformal Coated System | 1 | PVA (USA) | 3 Conformal Coated Robot System | | |
| system (1 Line) | Reflow M/C | 1 | Heller Korea | 7 zone reflow | | |



| Division | Equipment name | Number | Equipment Maker | Etc (SPEC) (2/2) | | | |
|------------------------------|---------------------------------------|--------|--|---|--|--|--|
| | Baking OVEN | 1 | Byum jin | Bare PCB dryer | | | |
| Materials | Micro Dry | 6 | Seli Richo | Main material dehumidifier | | | |
| warehouse | High speed dehumidifier | 7 | Seli Richo | Main material dehumidifier (After opening rapidity dehumidification function) | | | |
| | Vaccum Packaging | 1 | JS pac | Vacuum packaging equipment | | | |
| | X-RAY inspection M/C | 1 | SEC | X-EYE 51000F | | | |
| | Flying Probe ICT Tester | 1 | EMERIX | | | | |
| | Microscope Inspector | 1 | SOME TECH | CAMSCOPE | | | |
| | 40 times magnifying microscope system | 4 | Sehyun Trading | Attach to Monitor function, capture possible | | | |
| | Radiation measuring instrument | 1 | SEC | | | | |
| Inspector &
Environmental | Thermal shock tester | 1 | Byum jin | -20~80°c (Medium Chamber) | | | |
| equipment | Pressure tester | 2 | Dae Kwang | Withstanding voltage tester | | | |
| | Digital tensile strength meter | 1 | Yu Yu | Soldering removable test (component) | | | |
| | Large high temperature chamber | 1 | ALL THREE | $0~^{\circ}$ – $80~^{\circ}$ ($400~x~300~x~250cm$) | | | |
| | Forced converction Oven (PCB) | 2 | Byum jin, Core Tech | Max 250° (per 0.2°) | | | |
| | Thermo-hygrostat | 6 | Kiturami (Heating Cooling/Dehumidification) | PVU 50T7P1 (6 unit), Lage Type (120 m²) | | | |
| | Static Tester | 2 | Shinhan High Tech | ESC-670 (Shoe Tester) | | | |
| | lon blower | 16 | DIT | For the removal of static electricity (2P, 3P) | | | |
| Clean Room | Small clean room | 1 | Clean Booth – Class 1,000, HEPA FILTER (1492 x 572 x 75T) | | | | |
| Other measuring instruments | Measuring instrument and etc | 60 | BGA REWORK equipment, Calibrator, label printer, AC, DC POWER,, Analog Tester, Oscilloscope, illuminometer, surface resistance meter, reel counter, static test (HANDY), etc | | | | |



8. Manufacturing Operations Plan

| Content | | 2020 yr. | 2021 yr. | 2022 yr. | The present | |
|--------------------------|--------------------------------------|---|--|---|--|--|
| | SMT Line (4 Line) | SMT, 4 Line operate1 Shifts | SMT 5 Line review2 Shifts review | SMT 6 Line review2 Shifts operate | 1) A, D Line; Standard type
2) B, C Line: Large type | |
| | DIP Line (4 Line)_ Wave | 4 Line operatePb (2) , Pb free (2) | 4 Line reviewPb (2), Pb free (2) | 4 Line reviewPb (2), Pb free (2) | 1) A, B Line : Pb Line
2) C, D Line ; Pb Free (ROHS) | |
| Equipment
and Line | Robot Solder Line
(1 Line) | 1 Line operateSelective (2), Pointer (1) | 2 Line reviewSelective (4), Pointer (1) | 2 Line operateSelective (4), Pointer (1) | 1) Robot solder line operation 2) All used for Pb/ Pb Free | |
| operation | Function Cell Line
(10 Line) | Function 10 Cell Line Test & Repair room | • Function 14 Line | • Function 17 Line | 1) Function design
2) Repair room (BGA Reball) | |
| | Set test & assembly (6) | Customer set room (6) (Set test & assembly) | • Customer set room (9) (Set test & assembly) | • Customer set room (9) (Set test & assembly) | Customer set room (6)
(space : 120 m²) | |
| | Automatic coating line | Auto coating system(1 Line) | Auto coating system(1 Line) | Auto coating system(1 Line) | 3 Conformal Coated
Robot System | |
| | Manufacturing | 45 | 50 | 55 | | |
| Man
power | Purchase / Materials | 4/6 (10) | 10 | 10 | | |
| operation | Quality / Manufactuein
Management | 1/2/191 | | 10 | | |
| | Manufacturing
technology (Eng.) | 6 | 7 | 8 | | |
| Total operation manpower | | 70 | 77 | 83 | | |

9. Quality Process

Quality improvement 150 Operation

Quality improvement 150 Operation

Incoming defe

1,500 PPI

Improve quality

150 plan

Market de

O PPN

Ptocess de

150 PI

- market defect zero
- process defect 150ppm
- incoming defect 1,500ppm
- New customers and after mass production. Strengthening preventives activities and follow-up mass production
- Analysis & Improvement Tool
 - → type analysis PARETO diagram
 - → Trend management PPM management chart
- Way of Activity
 - → Weekly quality meeting: Every Tuesday
 - → Progress check meeting: Monthly
 - → Progress report : Monthly

Quality improvement strategy

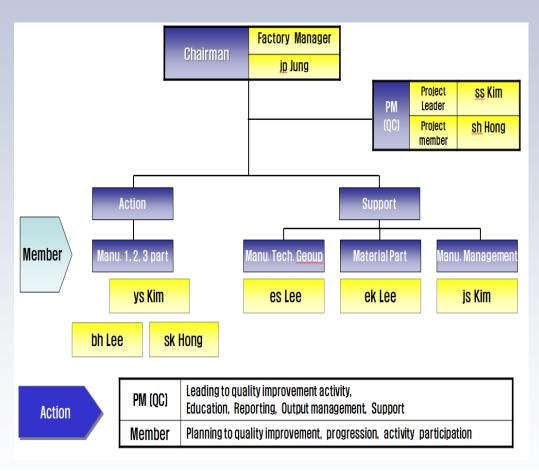
- O Customers require, Quality is 'zero defect' levels.
 - → There is no defect in LOT but in case of one critical defect, require quality improvement report.
 - → In order to meet customer demand rather than simple 'Reduction of defects' requires uniform manufacturing.
- 1. Improve quality in development stage
- 2. Improve manufacturing quality
- 3. Customer quality satisfication
- 4. One Team (strength cooperation among the members)

System

Human Resources

Technology

Quality Improvement Promotion Organization



Quality improvement plan

Development ~ **Initial producs quality stabilization**

Initial quality stabilization of manufacturing products

- The time transfer production, Check the history and Issue point
- Share Issue point in development stage (quality, manu. technology, 1/2/3 part)
- When launching of new model products, Concentration for process quality

Manufacturing quality stabilization

Improve process quality

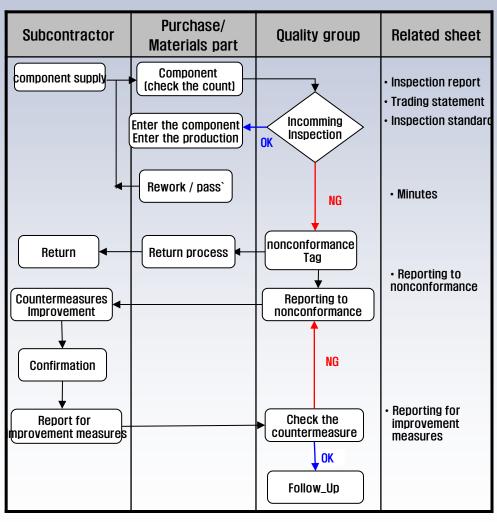
- Establish countermeasure to recurrence prevention from worst defect analysis
- Establish countermeasure after analysis, of the defect of operator error
- ① Operator quality awareness
- ② Check the system
- 3 Operation environment (3-way 5S) 4 Operator's body, psychological state

Customer Satisficaction

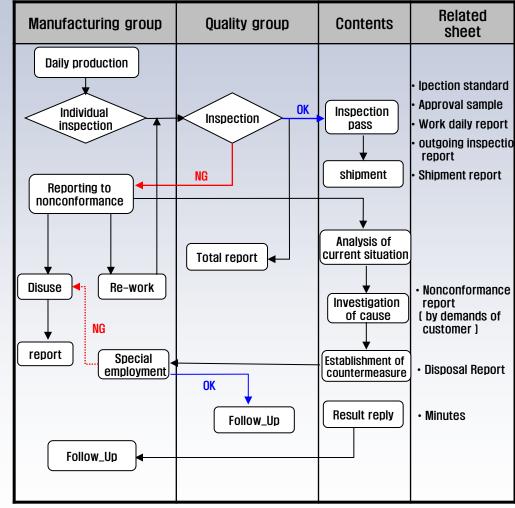
Establish a customer satisfication process

- Establishing a plan and improve problems by surveying customer satisfication.
- Establishing quality differentiation plan to applied to manufacturing line
- Establishing 3-way 5S operation plan to maintain manufacturing line need to ask the customer.

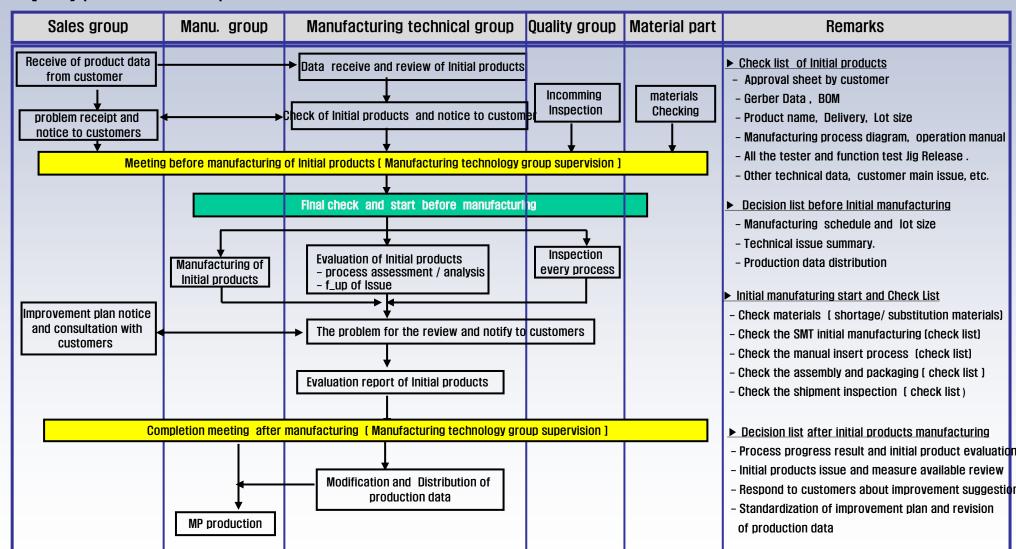
Incomming Inspection Process



Outgoing Inspection Process



Ouality process of Initial products



A4(297*210)

EMnex

Check sheet for process flow (every lot)



Check sheet for Initial products

MNEX705-22

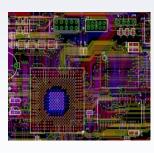
| J | 6- | 한탁기술
TECHNOLOGY
2014-11-26 | 초도품 | 성직 | 석서 | | 신규 | 생산 | # N
11 9 26 9 | # El (11 26 2 | | |
|-----------------------------|---|--|---------------|-------|----------------|-------------------|------|---|---------------------|---------------|--|--|
| 모델명 HTMC502J-MVB-Rev.B LOT수 | | | | | | 46 | | | 양 유 | 연납 | | |
| 1,5 | 고객사 한터기술 Line | | | | B-Line | | | 검사기 | 다 김 | 김상순 | | |
| NO | | Chec | k 사항 | | OK | NG | 해당없음 | | 비고 | 비고 | | |
| 1 | 기술변경 및 | 생산자료 (PL, 작 | 업지도서) 최신VER | 확인 | 0 | | | VER: (HT | MC502J-MVB-F | Rev.B) | | |
| 2 | PCB 외관불 | 량(패턴 벗겨짐, 휭 | , 오염) 없을 것 | | 0 | | | | | | | |
| 3 | PCB 피듀셜 | 마크, Guide V-C | ut 누락 없을 것 | | 0 | | | | | | | |
| 4 | PCB 극성 Si | lk Print 오류 없을 | · 것 | | 0 | | | | | | | |
| 5 | SPI 과납, 소 | 납, 틀어짐 등 없을 | 를 것
- | | 0 | | | | | | | |
| 6 | 부품 미출 시 | 고객사 승인 여부 | 부 확인 | | | | 0 | | | | | |
| 7 | 부품 Packag | ge 오류 없을 것 | | | 0 | | | | | | | |
| 8 | 부품 Spec S | 2류 없을 것 | | | 0 | | | | | | | |
| 9 | SMT 미삽 0 | 비상 없을 것 | | | o | | | 23월 (TOP - R1,R17,R31,R53,R54,
R55,R56,R57,R58,R62,R64,R66,
BOTTOM - C40,R83,R84,R85,R89,R90,
R93,R101,R106,R108,R111) | | | | |
| 10 | SMT 오삽(I | 대더검사) 이상 없 | 을 것 | | 0 | | | | | | | |
| 11 | SMT 역삽(= | 극성) 이상 없을 것 | | | 0 | | | | | | | |
| 12 | PCB 랜드 다 | 비 자재 Package | 오류 없을 것 (납명 | 댐 상태) | 0 | | | | | | | |
| 13 | 마스크 개구 | 부 사이즈 대비 란 | 드 오류 없을 것 | | 0 | | | | | | | |
| 14 | 핸들링(수탑) 실장 POINT 이상 없을 것 (중점관리 POINT) | | | | | | | | | | | |
| 15 | 컨베이어 통과 후 PSR 벗겨짐, 오염등 PCB상태 이상없을 것 | | | | | | | | | | | |
| 16 | BGA 오삽, | 역삽 , 미삽 , 들뜸 | 등 없을 것 | | 0 | | | XC3S1400AN-4FGG676I (U4)
AT91SAM9260B-CU (U5) | | | | |
| 17 | BGA 외관상 | 태 (팝콘 및 IC 칼 | 라짐) 이상 없을 것 | | 0 | | | XC3S1400AN-4FGG676I (U4)
AT91SAM9260B-CU (U5) | | | | |
| 18 | QFP 부위 소 | 납, 쇼트, 납젖음성 | 성 이상 없을 것 | | 2 3 | | 0 | | | | | |
| _ | | 국성 이상 없을 것 | | | 0 | | | SCO-103A | 24MHz, 3.3VE | C (OSC1) | | |
| 20 | IED ME A | 생상 , 납땜 상태 이 | 사이오기 | | 0 | | | SSC-GR10 | 1 ; Green | | | |
| | 100 mm | | | | 2.50 | | - | (LD1,LD2,L | .D3,LD4,LD5,LD6 | ,LD7,LD8) | | |
| _ | | | 재 시 냉땜 여부 확 | 인 | 0 | | | S. | | | | |
| 22 | 매거진 간섭 | 으로 인한 PCB II | r손 없을 것 | | 0 | | - | 42 CD4 2 | 54 D54 3 54 | (LID4) | | |
| 23 | HEADER PI | N 부품 리드 평탄 | 도 이상 없을 것(냉 | 팸 확인) | 0 | | | A2-6PA-2.54-DSA 2.54mm (HD1)
A2-2PA-2.54-DSA 2.54mm (HD2)
A1-20PA-2.54DSA,2.54mm (HD3) | | | | |
| | 점관리항목
계사 요구사항) | 2. 유사 부품 주의.
TPS78601DCQ [Ro
TPS78618DCQ [Ro | | | | | | | | | | |
| NO | | 문제점 | 임시조기 | Ч | 7 | 선 요청시 | 항 | 담당자 | 참고자료 | 개선여부 | | |
| 1 | AT915AM926 | OB-CU (U5)
에 2개가 존재하여 | Mouser 실물 확인후 | | 정품자자 인지 확인 필요. | | | | | | | |
| 2 | Crystal SSP-T7
현품표 없이 수
용량값 표기가 | | | | | 박 및 용량감
보기입 요청 | | | 1000 200
11-17-9 | | | |

(주)이엠넥스

10. Design & Technology







| _ | | | | | _ | | | |
|---|-----|---|-----|-----|-----|-----|-----|----|
| ш | пп | - | | 110 | | | 20 | gn |
| м | ı.ĸ | - | ΙIV | vii | IK | | -76 | |
| | | | LLA | V U | 111 | LUI | | |

- NX7/ NX70/ NX700 PLC PCB ARTWORK
- □ ROBOT Controller PCB ARTWORK
- Servo Driver PCB ARTWORK
- □ OLED Encapsulation Inkjet driver (SG1024)
- ☐ LCD Encapsulation Inkjet driver (V1, V2, V3)
- □ Elevator controller board
- **☐ SMART GLASS Controller**

Inspection equipment and function jig

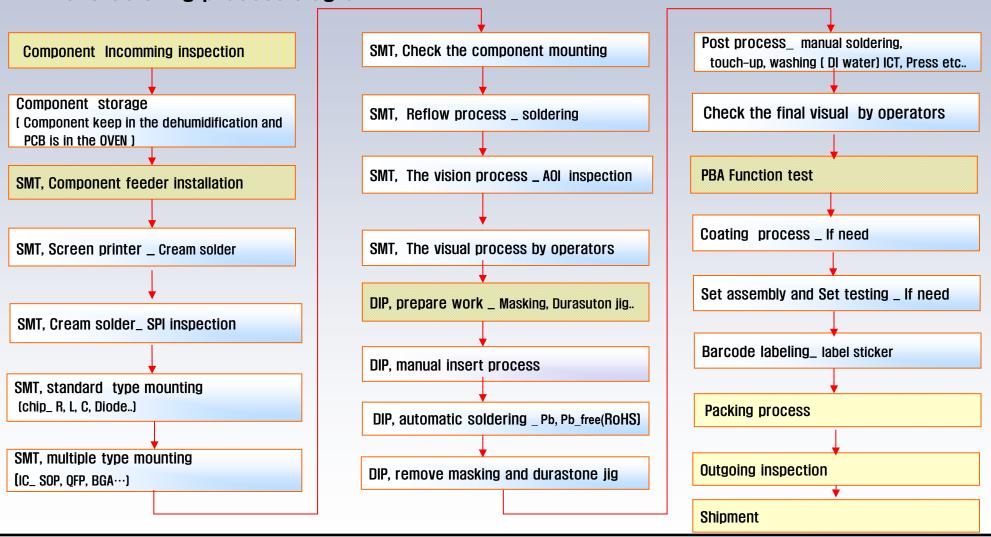
- ☐ PLC positioning module inspection equipment
- ☐ Firmware download Jig design
- ☐ Inkjet driver function jig design
- ☐ Elevator controller function jig design
- ☐ LED Power mass production process jig design

Plan and Engineering (technology)

- oxdot NX70/ NX700 PLC Enginering and CE/ UL approval
- ☐ I/O ASIC Development (circuit -> FPGA -> ASIC)
- ☐ Ultrasonic docking control module development.
- ☐ EtherCAT I/F & SERCOS module engineering
- ☐ Phase control B'D engineering
- ☐ AGV control system engineering
- □ Laser detector control system engineering
- ☐ Ultrasound Docking B'D development.
- □ OLED Inkiet driver (SG1024 driver) engineering
- LCD Inkjet driver (Jet driver V1, V2) engineering
- □ OLED Inkiet driver (Jet driver V3) engineering
- ☐ Elevator controller board development.
- ☐ SMART GLASS Controller development.
- ☐ LED Power module development.
- □ OLED KM Driver (KM V1,V2,V3) engineering
- □ Pulse DC Generator development .
- □ etc

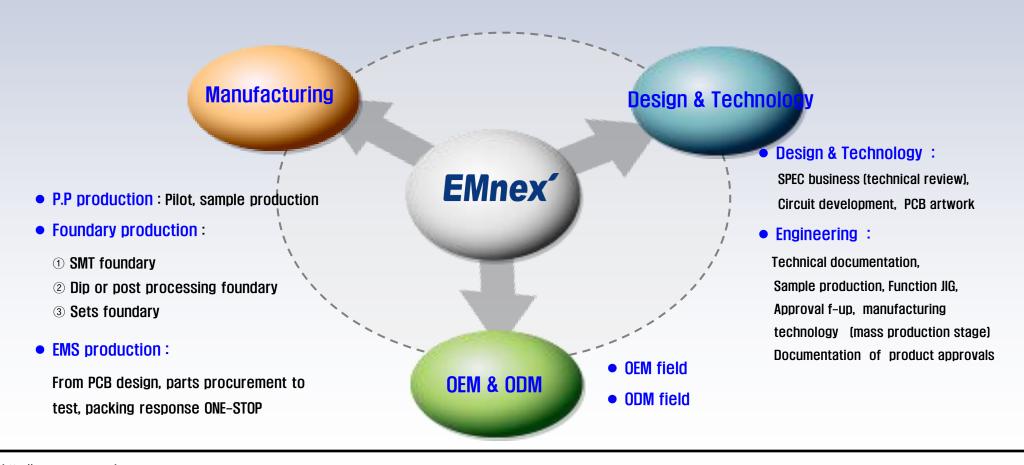


11. Manufacturing process diagram



12. EMNEX Business

EMNEX is capable of handling PCB artwork, parts purchase, assembly (SMT_ DIP process), testing, set assembly, packaging, and it supports from small lot production to mass production as below.



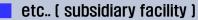










Table tennis court

Place of education

Women's rounge









